

Notice of References Cited		Application/Control No. 10/042,097	Applicant(s)/Patent Under Reexamination DIXON ET AL.	
		Examiner John P Trimmings	Art Unit 2133	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
*	A	US-6,631,486	10-2003	Komatsu et al.	714/724
*	B	US-6,563,298	05-2003	Creek et al.	324/158.1
*	C	US-5,548,525	08-1996	Albee et al.	716/4
*	D	US-6,374,379	04-2002	Walker et al.	714/724
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NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	IBM Technical Disclosure, "AC Chip in Place Test", NN74111607, November, 1974.
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*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.